

Features

- 0603 Top view SMD LED
- High reliability
- General purpose leads
- Peak wavelength λp=940nm
- Mechanically and spectrally matched to the phototransistor
- Low forward voltage
- High radiant intensity

Applications

- Optoelectronic Switch
- IR Touch-Panel
- Industrial IR Equipment
- Consumer Electronics
- High Speed IR Communications

Description

The IN-S63DTHIR is a popular 0603 top view package with versatile design capabilities. It is a PCB type molding style LED which can be used in various applications.

Recommended Solder Pattern

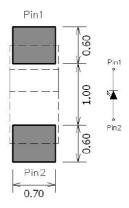
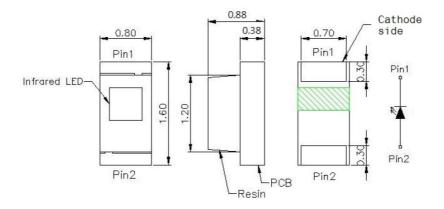


Figure 1. IN-S63DTHIR Solder Pattern

Package Dimensions in mm



Notes.

- 1. All dimensions are in millimeters.
- 2. Tolerance is ± 0.10 mm unless otherwise noted

Figure 2. IN-S63DTHIR Package Dimensions



Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P _d (mW)	I _F (mA)	I _{FP} * (mA)	V _R (V)	Top (°C)	T _{ST} (°C)
IN-S63DTHIR	Infrared	100	65	500	5	-40°C~+85°C	-40°C~+100°C

Notes

1. IFP Conditions--Pulse Width ≦ 100µs and Duty ≦ 1%.

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

Electrical Characteristics $T_A = 25\%$ (Note 1)

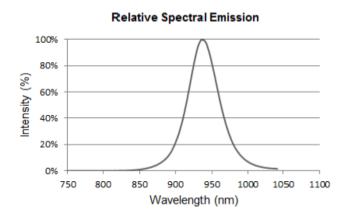
			V _F (V)		λ(nm)			Viewing Angle	le (mW/sr)
Product	Emission Color	I _F (mA)	min	max	λD	λ P	Δλ	201/2	typ.
IN-S63DTHIR	Infrared	20	1.0	1.5	-	940	50	140	0.8

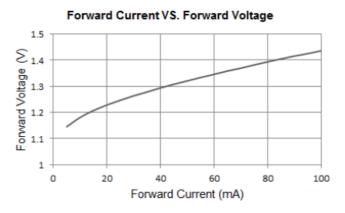
Notes

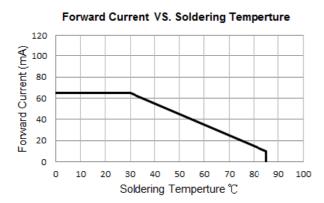
1. Performance guaranteed only under conditions listed in above tables.

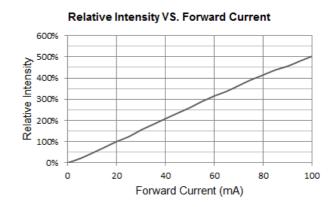


Typical Characteristic Curves

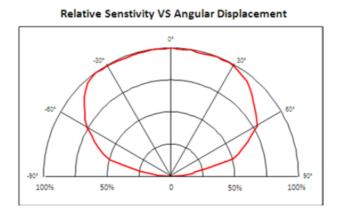








Typical Characteristic Curves – Radiation Pattern

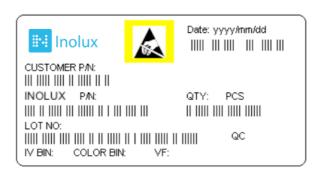




Ordering Information

Product	Emission Color	Technology	Test Current I _F (mA)	Radiant Intensity le (mW/sr) (Typ.)	Forward Voltage V _F (V) (Typ.)	Orderable Part Number
IN-S63DTHIR	Infrared	AlGaAs	20	0.8	1.2	IN-S63DTHIR

Label Specifications



Inolux P/N:

I	N	-	S	63	D	T			HIR	-	Х	Х	Х	Х
			Material	Package	Variation	Orientation	Current	Lens	Color				mized p-off	
In	olux		PCB - S	63D = 060	3 0.88mm	T = Top Mount	(Blank) = 20mA	(Blank) = clear	HIR = 940nm					

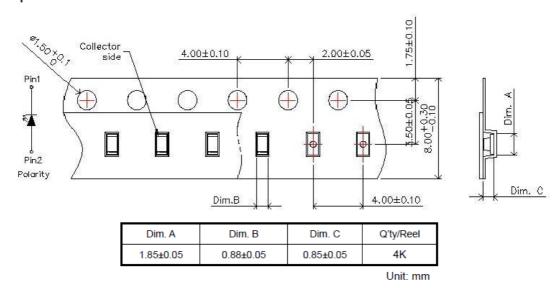
Lot No.:

Z	2	0	1	7	01	24	001
Internal		Voor (2017	2019 \	Month	Data	Serial	
Tracker		Year (2017	, 2016,)	IVIOITUI	Date	Seriai	

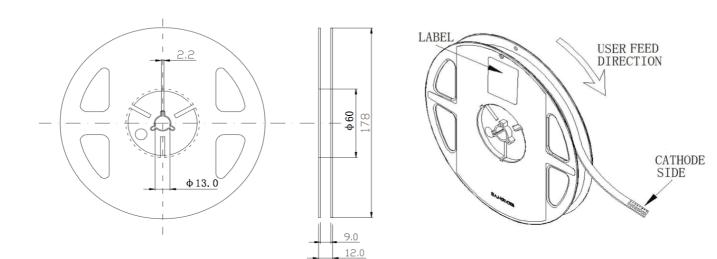


Packaging Information: 4000pcs Per Reel

Packaging Tape Dimension

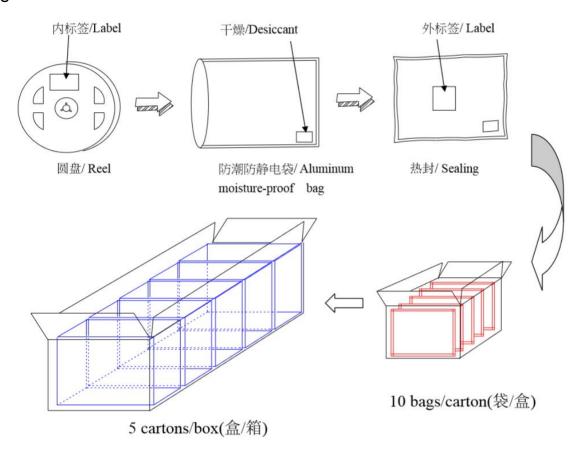


Reel Dimension





Packing Dimension



5 boxes per carton are available depending on shipment quantity.

	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	4000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_P and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

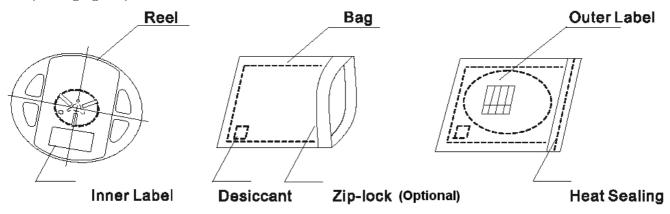


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

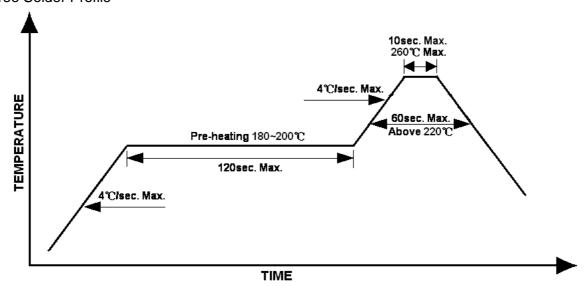
The packaging sequence is as follows:



Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

Lead-free Solder Profile





Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.





Reliability

enability							
Item	Frequency/ lots/ samples/ failures	Standards Reference	Conditions				
	For all reliability	J-STD-020	1.) Baking at 85°C for 24hrs				
Precondition	monitoring tests according	J-31D-020	2.) Moisture storage at 85°C/ 60% R.H. for				
riecondition	to JEDEC Level 2		168hrs				
	1Q/ 1/ 22/ 0	JESD22-B102-B	Accelerated aging 155°C/ 24hrs				
Solderability	10/ 1/ 22/ 0	And CNS-5068	Tinning speed: 2.5+0.5cm/s				
Solderability		And Civo-3000	Tinning speed: 2.5+0.5cm/s Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s				
		CNS-5067	Dipping soldering terminal only				
Resistance to		0110-3007	Soldering bath temperature				
soldering heat			A: 260+/-5°C; 10+/-1s				
Soldering near			B: 350+/-10°C; 3+/-0.5s				
	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs				
Operating life test	19/1/40/0	0110-11029	85°C/ 60%R.H. for 168hrs				
Operating me test			2.) Tamb25°C; IF=20mA; duration 1000hrs				
High humidity,	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C				
high temperature	10/ 1/ 45/ 0	JESD-ATUT-B	Humidity: 85% R.H., IF=5mA				
bias			Duration: 1000hrs				
	1Q/ 1/ 20	IN specs.	Tamb: 55°C				
High temperature	10/ 1/ 20	in specs.	IF=20mA				
bias			Duration: 1000hrs				
	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty				
Pulse life test	10/ 1/ 40/ 0		cycle=0.125 (tp=125 μ s,T=1sec)				
ruise ille test			Duration 500hrs)				
	1Q/ 1/ 76/ 0	JESD-A104-A	A cycle: -40 degree C 15min; +85 degree C				
	TQ/ 1/ 76/ U	IEC 68-2-14, Nb	15min				
Temperature		IEC 66-2-14, IND	Thermal steady within 5 min				
cycle			300 cycles				
			2 chamber/ Air-to-air type				
High humidity	1Q/ 1/ 40/ 0	CNS-6117	60+3°C				
storage test	10/ 1/ 40/ 0	CING-0117	90+5/-10% R.H. for 500hrs				
	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs				
High temperature	10/ 1/ 40/ 0	UNO-004	100+10 6 101 5000118				
storage test	10/1/40/0	CNC 6440	40 LEOC for EOObro				
Low temperature	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs				
storage test							



Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	01-29-2019

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- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.